## PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

**SUBMISSION TYPE: NEW ASSIGNMENT** 

NATURE OF CONVEYANCE: **ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
TAKEO OKABE	09/02/2005

#### **RECEIVING PARTY DATA**

Name:	NIKKO MATERIALS CO., LTD.
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Internal Address:	MINATO-KU
City:	токуо
State/Country:	JAPAN
Postal Code:	105-0001

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12778283

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER: melodymarsden

Total Attachments: 2

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> **PATENT** REEL: 024373 FRAME: 0786

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#### ASSIGNMENT

WHEREAS, Takeo Okabe, hereinafter referred to as ASSIGNOR, has invented and is the owner of an invention entitled COPPER ALLOY SPUTTERING TARGET, PROCESS FOR PRODUCING THE SAME AND SEMICONDUCTOR ELEMENT WIRING, said invention being fully set forth and described in the application for Letters Patent of the United States which has been prepared in connection with said invention, and which has been signed by ASSIGNOR; and

WHEREAS, Nikko Materials Co., Ltd., a Japanese corporation engaged in business at 10-1, Toranomon 2-chome, Minato-ku, Tokyo, 105-0001 Japan, hereinafter referred to as ASSIGNEE, is desirous of acquiring the said invention and any and all applications for Letters Patent and any and all Letters Patent of the United States and foreign countries which may be issued therefor;

NOW THEREFORE, THIS IS TO WITNESS, that in consideration of the sum of One Dollar (\$1.00) paid to ASSIGNOR by ASSIGNEE, the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR has sold, assigned and set over, and hereby does sell, assign and set over, unto ASSIGNEE, its successors and assigns, the entire right, title and interest for, to and within the United States and all foreign countries, in and to the aforesaid invention and in and to any and all application for Letters Patent and Letters Patent which may be issued therefor in the United States and in any and all foreign countries.

And ASSIGNOR hereby authorizes and requests the Commissioner of Patent and Trademarks to issue any and all Letters patent of the United States to ASSIGNEE, its successors and assigns, as the owner of all right, title and interest therein.

And for said consideration, it is hereby covenanted and agreed that at the request and expense of ASSIGNEE, its successors and assigns, ASSIGNOR will execute any further papers and do such other acts and things as may be necessary and proper to procure Letters Patent for said invention in the United States and in such foreign countries as ASSIGNEE, its successors and assigns may elect, and vest the full title thereto in ASSIGNEE, its successors and assigns.

And ASSIGNOR hereby authorizes and directs its attorneys to insert, in the space provided below, the serial number and filing date of the aforesaid application for Letters Patent of the United States when the same shall have been made known to them by the United States Patent and Trademark Office.

PATENT REEL: 024373 FRAME: 0787 IN WITNESS WHEREOF, this Assignment has been executed by us on the date accompanying my signature.

und Opm

Takeo Okabe

(Date)

Application for United States Letters patent Serial Number 10/549,440

filed September 16, 2005

HOWSON AND HOWSON